



75B'Vig'9G8'dfchYWh]cb'X]cXY'

:YUhfYg'

" (SR[\ PHHWV 8/ 9ELIOLDP\ PUDWLQJ' DQG KDORJH
 " 0RLVWXUH 6HQVLWLYLW\ /HYHO
 " 'XDO /LQH &\$1H%WRURW 627 3DFNDJH
 " 0D[3HDN 3XOVH 3RZHU : SHU /LQH WS V
 " / QøtpD7L7H S P D Q D C V OHDGV VROGHUDEOH SHU - 6
 DQG -(6' %
 " Auf_jb[Ö 56

vAUI]aia'FUh]b[g' 7D - 8QOHVV RWKHUZZLVH VSHFLILHG

D5F5A9H9F'	GMA6C@'	IB-H'	J5@19'
3HDN 3XOVH 3RZHU SHU ÄUQWÄ WS	V 3 ₃₃	:	
3HDN 3XOVH &XUUHQW S ÄUQWÄ WS	3 ₃		\$
6WRUDJH 7HPSHUDWXUH 5DQJH	7 _{VWJ}	f &	a

-XQFWLRQ 7HPSHUDWXUH "hFCr' !Qh0

		N 9	
, (& FRQWDFWÄ GRWÄHKDUJH		N 9	

1RW01RQ UHSHWLWLYH FXUUHQW SXOVH DFFRU]SRQJHWRDQ GHFD\ ZDYHIRUP
 1RW0HDVXUHG IURP SLQ WR RU WR

v9`YWhf]WU`7\UfUWhYf]gh]Wg' 7D XQOHVV RWKHUZZLVH QRW

-H9A'	GMA6C@'	IB-H'	7CB8-H-CBG'	A-B''	HMD''	A5L''
5HYHUVH :RUNLQJ 9ROWDJH	5:0	9 9				
5HYHUVH %UHDNGRZQ 9ROWDJH %5			9 P \$ 9		,	
5HYHUVH /HDNDJH &XUUHQW	5		, 5:0 9 Q \$			9
&ODPSLQJ \$RQWDR RU WR	9&		33 \$ 9 3XOVH		,	
	9&		33 \$ 9 3XOVH		,	
	9&		33 \$ 9 3XOVH		,	
-XQFWLRQ &SDQFLWRQ FHRU	WR&M		5 9 I 0\$ = 9VLJ s P9			9





vCfXYf]b[-bZcf aUh]cb ([DP SOH

DF9:9F98'D#B'	D57?B; 7C89'	IB=H'K9=; <Hfl[L	A=B=A I A' D57?5; 9fidWgŁ	=BB9F'6CL' E I 5BH=HMfidWgŁ	C I H9F'75FHCB' E I 5BH=HMfidWgŁ	89@=J9FM'AC89
(6' & \$1 7 6 4)	\$SSUR[L P DWH				

'C i h']b Y' 8] a Ybg]cbg'

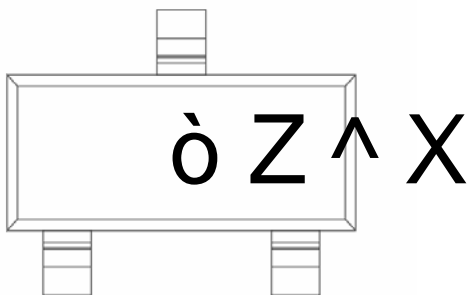
SYMBOL	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.035	0.045	0.900	1.150
A1	0.000	0.004	0.000	0.100
E	0.025	0.041	0.900	1.050

NO. 1: 1.5% PACKAGE BURNS.
2: TOLERANCE AT THE PAD L.

UNIT: mm

SUGGESTED SOLDER PAD LAYOUT

vAUf_]b[-bZcf aUh]cb



1RWH
 \$OO PDUNLQJ LV DW PLGGOH RI WKH SURGXFW ERG\
 \$OO PDUNLQJ LV LQ ODVHU PDUNLQJ
 %RG\ FRORU %ODFN



8]gW'U]a Yf

7KH LQIRUPDWLRQ SGRV#DMPHIG (LyQ. BVHK @VP K FW_ANT